

# NSR0130P2T5G

## Schottky Barrier Diode

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

### Features

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.385 V (max) @  $I_F = 10$  mA
- Low Reverse Current
- This is a Pb-Free Device

### MAXIMUM RATINGS

| Rating   | Symbol    | Value | Unit |
|--|-----------|-------|------|
| Reverse Voltage  | $V_R$     | 30    | Vdc  |
| Forward Current DC   | $I_F$     | 100   | mA   |
| Forward Current Surge Peak<br>(60 Hz, 1 cycle)                         | $I_{FSM}$ | 1.0   | A    |
| ESD Rating: Class 3B per Human Body Model<br>Class B per Machine Model |           |       |      |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### THERMAL CHARACTERISTICS

| Characteristic   | Symbol          | Max            | Unit                       |
|--|-----------------|----------------|----------------------------|
| Total Device Dissipation FR-5 Board,<br>(Note 1) $T_A = 25^\circ\text{C}$<br>Derate above $25^\circ\text{C}$ | $P_D$           | 200<br>2.0     | mW<br>mW/ $^\circ\text{C}$ |
| Thermal Resistance, Junction-to-Ambient  | $R_{\theta JA}$ | 600            | $^\circ\text{C}/\text{W}$  |
| Junction and Storage<br>Temperature Range  | $T_J, T_{stg}$  | -55 to<br>+125 | $^\circ\text{C}$           |

1. FR-5 Minimum Pad.

### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

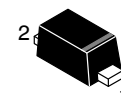
| Characteristic   | Symbol | Min    | Typ    | Max            | Unit          |
|--|--------|--------|--------|----------------|---------------|
| Reverse Leakage<br>( $V_R = 10$ V)<br>( $V_R = 30$ V)    | $I_R$  | -<br>- | -<br>- | 0.35<br>3.0    | $\mu\text{A}$ |
| Forward Voltage<br>( $I_F = 10$ mA)<br>( $I_F = 100$ mA) | $V_F$  | -<br>- | -<br>- | 0.385<br>0.525 | Vdc           |



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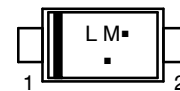
<http://onsemi.com>

## 30 V SCHOTTKY BARRIER DIODE



SOD-923  
CASE 514AA  
PLASTIC

### MARKING DIAGRAM



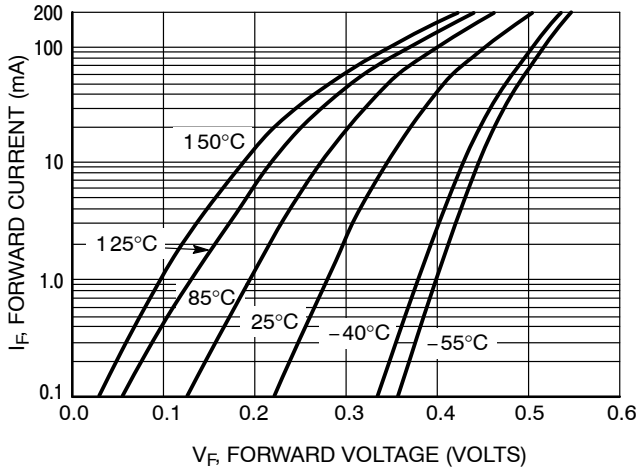
L = Specific Device Code\*  
(Character is rotated 270° clockwise)  
M = Month Code  
▪ = Pb-Free Package  
(Note: Microdot may be in either location)

### ORDERING INFORMATION

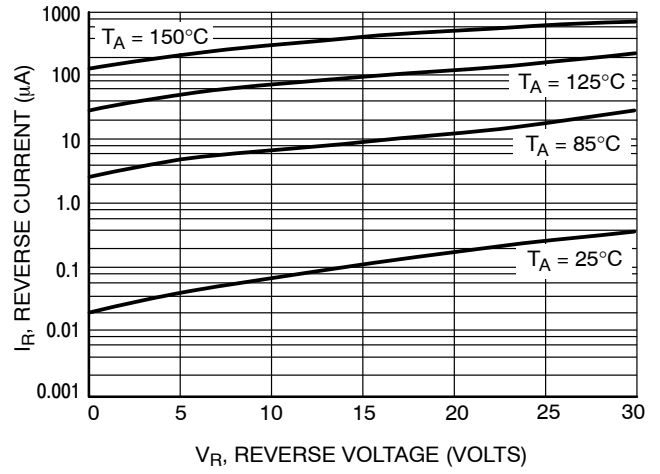
| Device       | Package | Shipping†                      |
|--------------|---------|--------------------------------|
| NSR0130P2T5G | SOD-923 | 2 mm Pitch<br>8000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

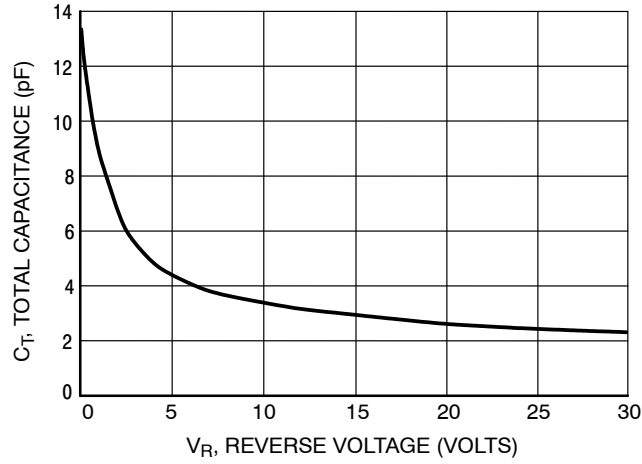
# NSR0130P2T5G



**Figure 1. Forward Voltage**



**Figure 2. Leakage Current**

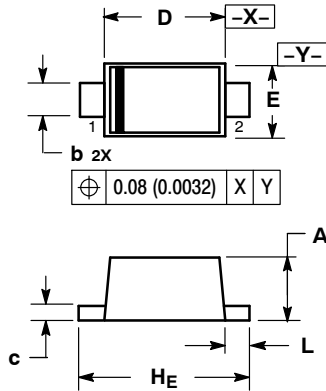


**Figure 3. Total Capacitance**

# NSR0130P2T5G

## PACKAGE DIMENSIONS

**SOD-923**  
CASE 514AA-01  
ISSUE B

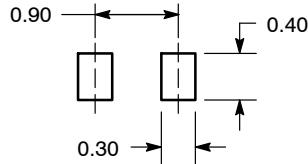


**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

| DIM                  | MILLIMETERS |      |      | INCHES |       |       |
|----------------------|-------------|------|------|--------|-------|-------|
|                      | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| <b>A</b>             | 0.36        | 0.40 | 0.43 | 0.014  | 0.016 | 0.017 |
| <b>b</b>             | 0.15        | 0.20 | 0.25 | 0.006  | 0.008 | 0.010 |
| <b>c</b>             | 0.07        | 0.12 | 0.17 | 0.003  | 0.005 | 0.007 |
| <b>D</b>             | 0.75        | 0.80 | 0.85 | 0.030  | 0.031 | 0.033 |
| <b>E</b>             | 0.55        | 0.60 | 0.65 | 0.022  | 0.024 | 0.026 |
| <b>H<sub>E</sub></b> | 0.95        | 1.00 | 1.05 | 0.037  | 0.039 | 0.041 |
| <b>L</b>             | 0.05        | 0.10 | 0.15 | 0.002  | 0.004 | 0.006 |

## SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

## SOD-923

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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